

300mA High Performance Low-Dropout Linear Regulator

Features

- Input voltage range: 1.4V to 5.5V
- Fixed outputs of 1.1V, 1.2V, 1.5V, 2.5V, 2.85V, 2.9V, 2.95V, 3.0V, 3.1V, 3.3V
- Rated output current: 300mA
- Quiescent current: typical 50 μ A
- Typical 0.1 μ A shutdown current
- Typical 158mV dropout voltage ($I_{OUT}=300mA$, 3.3V output)
- Power supply rejection ratio: typical 85dB ($I_{OUT}=30mA$, freq=1kHz, 3.3V output)
- Noise: typical 46 μ Vrms ($I_{OUT}=30mA$, BW=10Hz to 100kHz, 3.3V output)
- Built-in output short protection: typical 120mA when output short to ground
- DFN 1mm $\times$ 1mm $\times$ 0.37mm-4L package

General Description

AW37030YXXXE is a low dropout voltage regulator featuring low ON resistance, high PSRR, low Noise, good load/line transient response and smooth soft-start.

AW37030YXXXE integrates current limit, short circuit protection, thermal shutdown, sufficiently protecting IC from being damaged.

AW37030YXXXE is designed to work with a 1 μ F or more input ceramic capacitor and a 1 μ F or more output ceramic capacitor. The low power dissipation and good dynamic response make AW37030YXXXE very suitable for hand-held communication equipment. Tiny package makes high density mounting of the IC on boards possible.

Applications

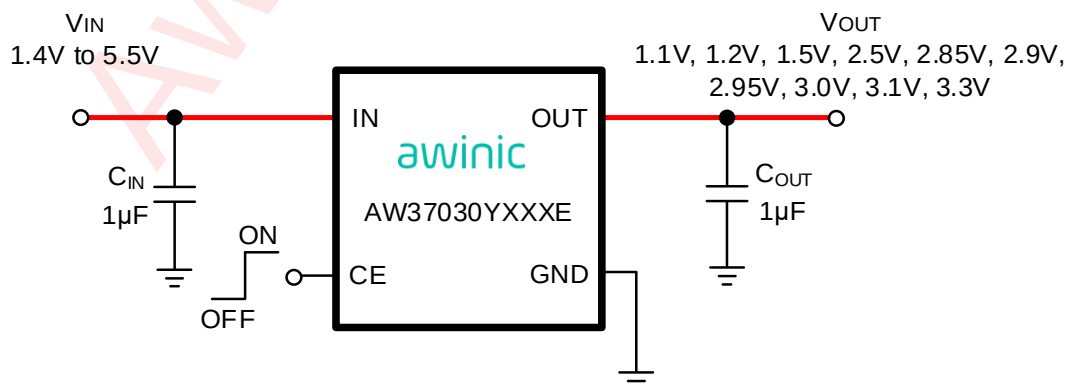
Battery-powered equipment

Smart phone

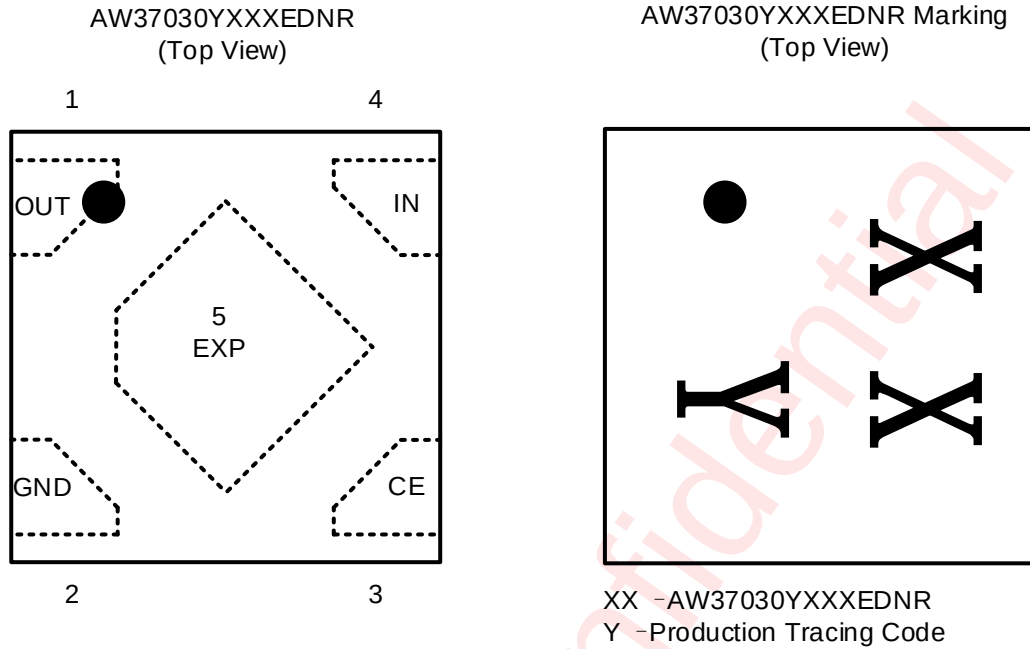
Digital camera

STB

Typical Application Circuit



Pin Configuration And Top Mark



Pin Definition

No.	NAME	DESCRIPTION
1	OUT	Regulated output voltage pin. Put a 1 μ F or more ceramic capacitor at the output pin.
2	GND	Ground.
3	CE	Chip enable pin. Built-in 140nA pull-down current. (High Active)
4	IN	Input supply pin. Put a 1 μ F or more bypass capacitor at the power supply.
5	EXP	Expose pad should be tied to ground plane for better power dissipation.

Name Rule

AW37 030 Y XXX E ZZZ

Package

DNR: DFN 1mm×1mm×0.37mm-4L

Output Voltage

E.g.

330: Output Voltage 3.3V

Auto-discharge Function

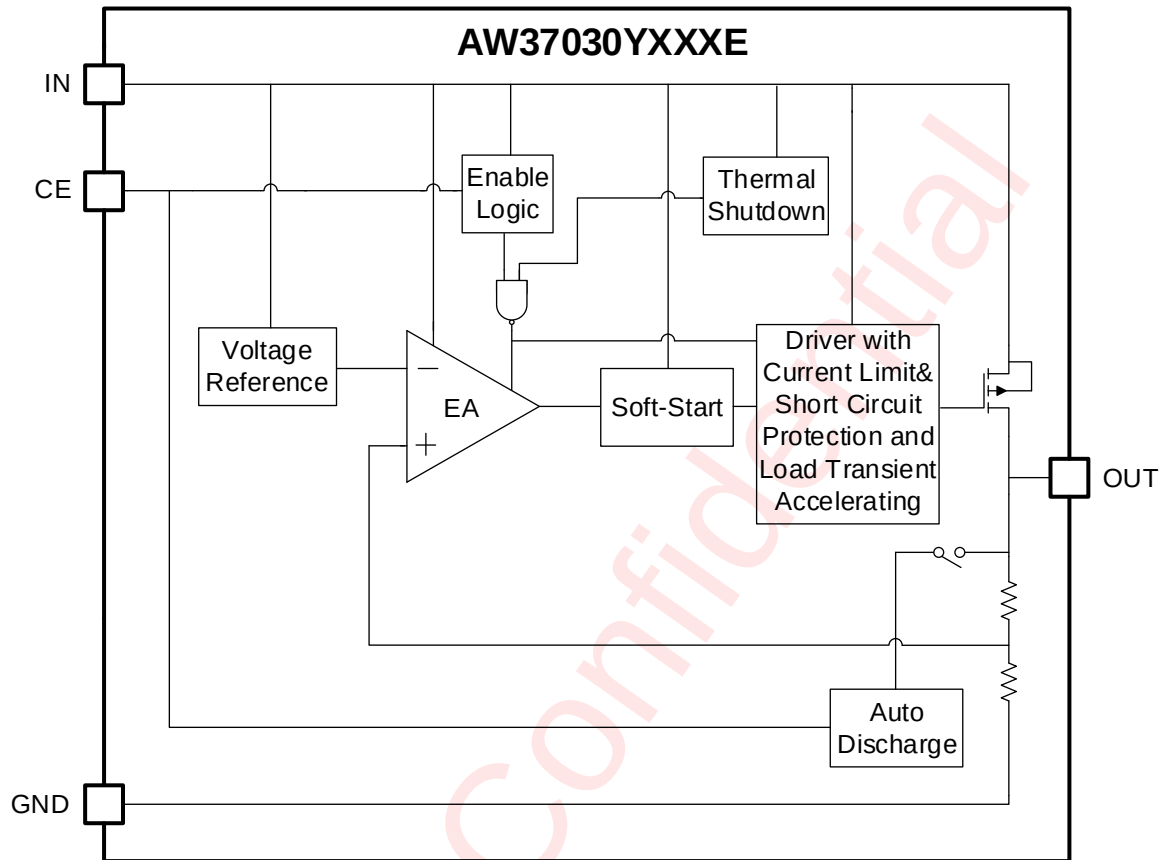
D: Available

B: Not available

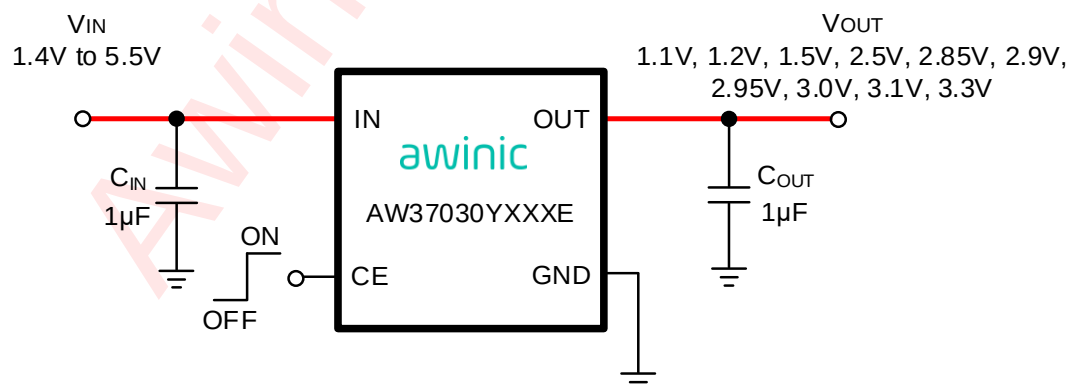
Rated Current

030: Rated Current 300mA

Functional Block Diagram



Typical Application Circuits



AW37030YXXxE Application Circuit

Notice for typical application circuits:

Capacitance of C_{IN} and C_{OUT} should be 1μF or more.

Ordering Information

Part Number	Temperature	Package	Marking	Moisture Sensitivity Level	Environmental Information	Delivery Form
AW37030D110EDNR	-40°C~85°C	DFN 1mm×1mm-4L	VE	MSL1	ROHS+HF	3000 units/ Tape and Reel
AW37030D120EDNR	-40°C~85°C	DFN 1mm×1mm-4L	SE	MSL1	ROHS+HF	3000 units/ Tape and Reel
AW37030D150EDNR	-40°C~85°C	DFN 1mm×1mm-4L	CR	MSL1	ROHS+HF	3000 units/ Tape and Reel
AW37030D250EDNR	-40°C~85°C	DFN 1mm×1mm-4L	J4	MSL1	ROHS+HF	3000 units/ Tape and Reel
AW37030D285EDNR	-40°C~85°C	DFN 1mm×1mm-4L	2V	MSL1	ROHS+HF	3000 units/ Tape and Reel
AW37030D290EDNR	-40°C~85°C	DFN 1mm×1mm-4L	HH	MSL1	ROHS+HF	3000 units/ Tape and Reel
AW37030D295EDNR	-40°C~85°C	DFN 1mm×1mm-4L	C2	MSL1	ROHS+HF	3000 units/ Tape and Reel
AW37030D300EDNR	-40°C~85°C	DFN 1mm×1mm-4L	VA	MSL1	ROHS+HF	3000 units/ Tape and Reel
AW37030D310EDNR	-40°C~85°C	DFN 1mm×1mm-4L	RJ	MSL1	ROHS+HF	3000 units/ Tape and Reel
AW37030D330EDNR	-40°C~85°C	DFN 1mm×1mm-4L	PP	MSL1	ROHS+HF	3000 units/ Tape and Reel

Absolute Maximum Ratings^(NOTE1)

PARAMETERS		RANGE
Input voltage range		-0.3V to 6.5V
Enable control voltage range		-0.3V to 6.5V
Output voltage range		-0.3V to VIN+0.3V, max. 6.5V
Maximum operating junction temperature T _{J_MAX}		150°C
Recommended operating junction temperature T _{J_REC}		-40°C to 125°C
Operating free-air temperature range		-40°C to 85°C
Storage temperature T _{STG}		-65°C to 150°C
Lead temperature (soldering 10 seconds)		260°C
Junction-to-ambient thermal resistance R _{θJA} ^(NOTE2)		170°C/W
Maximum power consumption, T _A =25°C, T _{J_REC} =125°C		588mW
ESD	HBM (Human body model) ^(NOTE3)	±2kV
	CDM(Charged device model) ^(NOTE4)	±1.5kV
Latch-Up ^(NOTE5)		+IT: 200mA - IT: -200mA

NOTE1: Conditions out of those ranges listed in "absolute maximum ratings" may cause permanent damages to the device. In spite of the limits above, functional operation conditions of the device should within the ranges listed in "recommended operating conditions". Exposure to absolute-maximum-rated conditions for prolonged periods may affect device reliability.

NOTE2: Thermal resistances follow JEDEC 2S2P standards, and is usually highly dependent on PCB layout.

NOTE3: All pins. Test Condition: ESDA/JEDEC JS-001-2017.

NOTE4: All pins. Test Condition: ESDA/JEDEC JS-002-2018.

NOTE5: Test Condition: JESD78E.

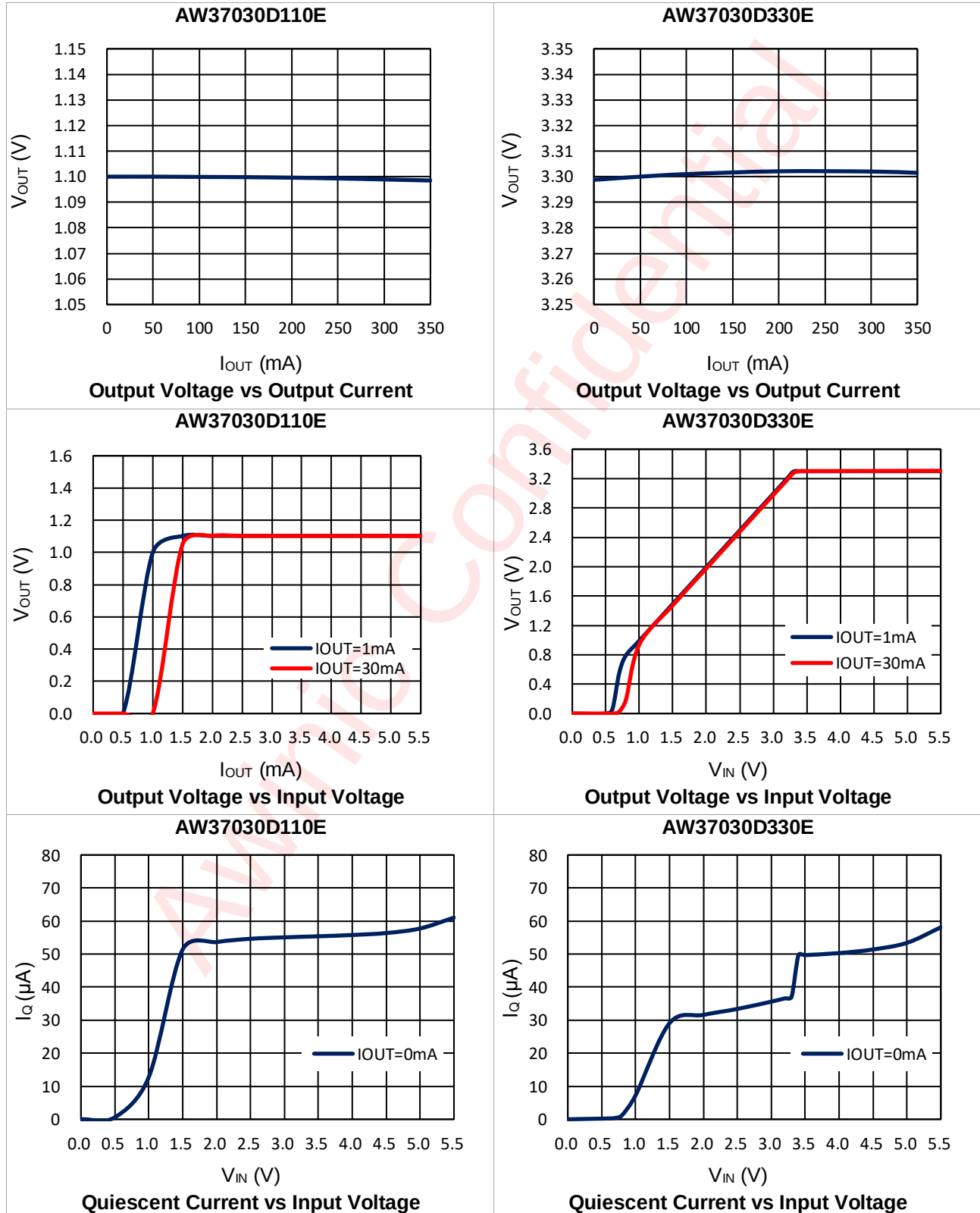
Electrical Characteristics

$V_{IN}=V_{OUT(SET)}+1V$, $V_{CE}>1V$, $I_{OUT}=1mA$, $C_{IN}=C_{OUT}=1\mu F$, $T_A=25^{\circ}C$ (unless otherwise noted)

PARAMETER		TEST CONDITION		MIN	TYP	MAX	UNIT
V_{IN}	Input Voltage Range			1.4		5.5	V
V_{OUT_ACC}	Output Voltage Accuracy	$T_A=25^{\circ}C$		-1		1	%
		$-40^{\circ}C \leq T_A \leq 85^{\circ}C$		-2		2	
$LOAD_{Reg}$	Load Regulation	$1mA \leq I_{OUT} \leq 300mA$			1	20	mV
$LINE_{Reg}$	Line Regulation	$V_{OUT(SET)}+0.5V \leq V_{IN} \leq 5.5V$			1	5	mV
$V_{dropout}$	Dropout Voltage	$I_{OUT}=300mA$, When V_{OUT} falls 100mV below $V_{OUT(SET)}$	$V_{OUT(SET)}=1.1V$		680	884	mV
			$V_{OUT(SET)}=1.2V$		576	749	
			$V_{OUT(SET)}=2.5V$		203	264	
			$V_{OUT(SET)}=3.0V$		175	228	
			$V_{OUT(SET)}=3.3V$		158	205	
I_{SD}	Shutdown Current	$V_{CE}<0.4V$			0.1	1	μA
I_Q	Quiescent Current	$I_{OUT}=0mA$			50	100	μA
V_{CEH}	CE Input Voltage "H"	$-40^{\circ}C \leq T_A \leq 85^{\circ}C$		1			V
V_{CEL}	CE Input Voltage "L"	$-40^{\circ}C \leq T_A \leq 85^{\circ}C$				0.4	V
$PSRR$	Power Supply Ripple Rejection	$I_{OUT}=30mA$, $f=1kHz$ $V_{OUT(SET)}=3.3V$			85		dB
V_N	Output Voltage Noise	$I_{OUT}=30mA$ $BW=10Hz$ to $100kHz$	$V_{OUT(SET)}=1.1V$		21		μV_{rms}
			$V_{OUT(SET)}=3.3V$		46		
I_{CL}	Output Current Limit	$V_{OUT}=90\% \cdot V_{OUT(SET)}$		300			mA
I_{SC}	Short Current Limit	$V_{OUT}<10\% \cdot V_{OUT(SET)}$			120		mA
VTC	Output Voltage Temperature Coefficient	$-40^{\circ}C \leq T_A \leq 85^{\circ}C$			± 40		ppm/ $^{\circ}C$
R_{DISC}	Auto Discharge Resistance	$V_{IN}=4V$, $V_{CE}<0.4V$, $V_{OUT}=3V$			130		Ω
I_{CE}	CE Pull Down Current				140		nA
T_{SDH}	Thermal Shutdown Threshold	Temperature Rising			160		$^{\circ}C$
T_{SDL}	Thermal Shutdown Reset Threshold	Temperature Falling			130		$^{\circ}C$

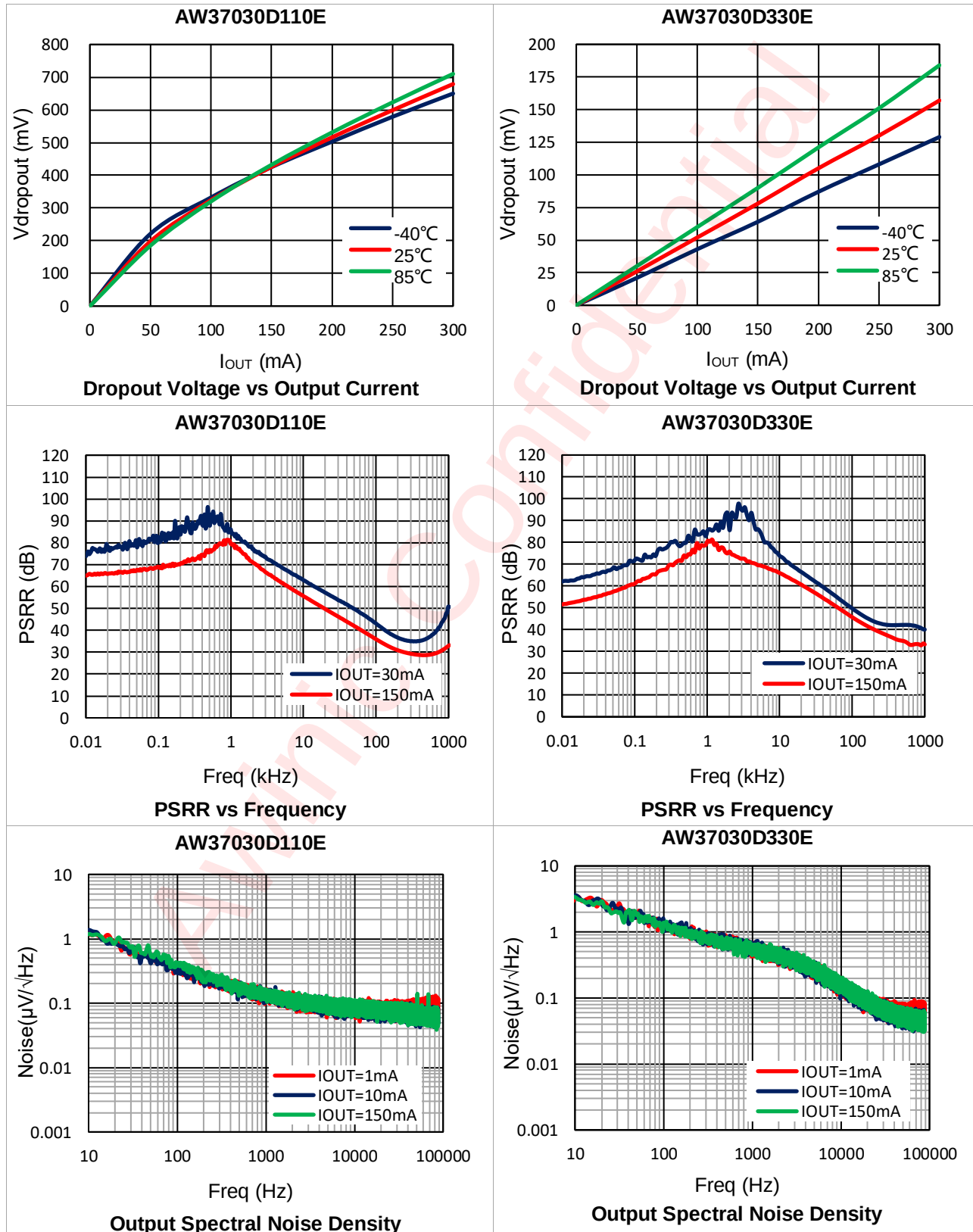
Typical Characteristics

$V_{IN}=V_{OUT(SET)}+1V$, $V_{CE}>1V$, $I_{OUT}=1mA$, $C_{IN}=C_{OUT}=1\mu F$, $T_A=25^{\circ}C$, in Typical Application Circuit, unless otherwise noted.



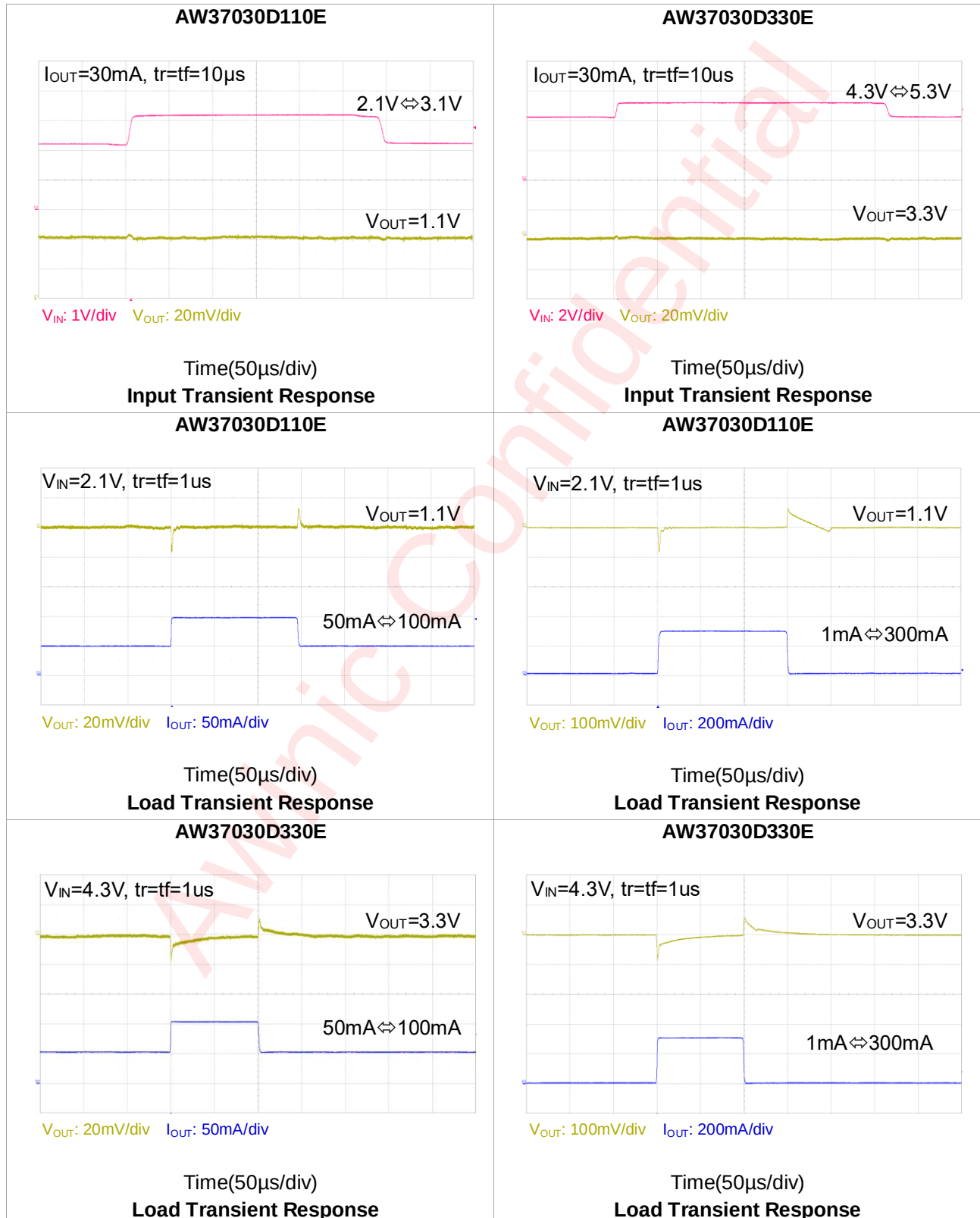
Typical Characteristics (Continued)

$V_{IN}=V_{OUT(SET)}+1V$, $V_{CE}>1V$, $I_{OUT}=1mA$, $C_{IN}=C_{OUT}=1\mu F$, $T_A=25^{\circ}C$, in Typical Application Circuit, unless otherwise noted.



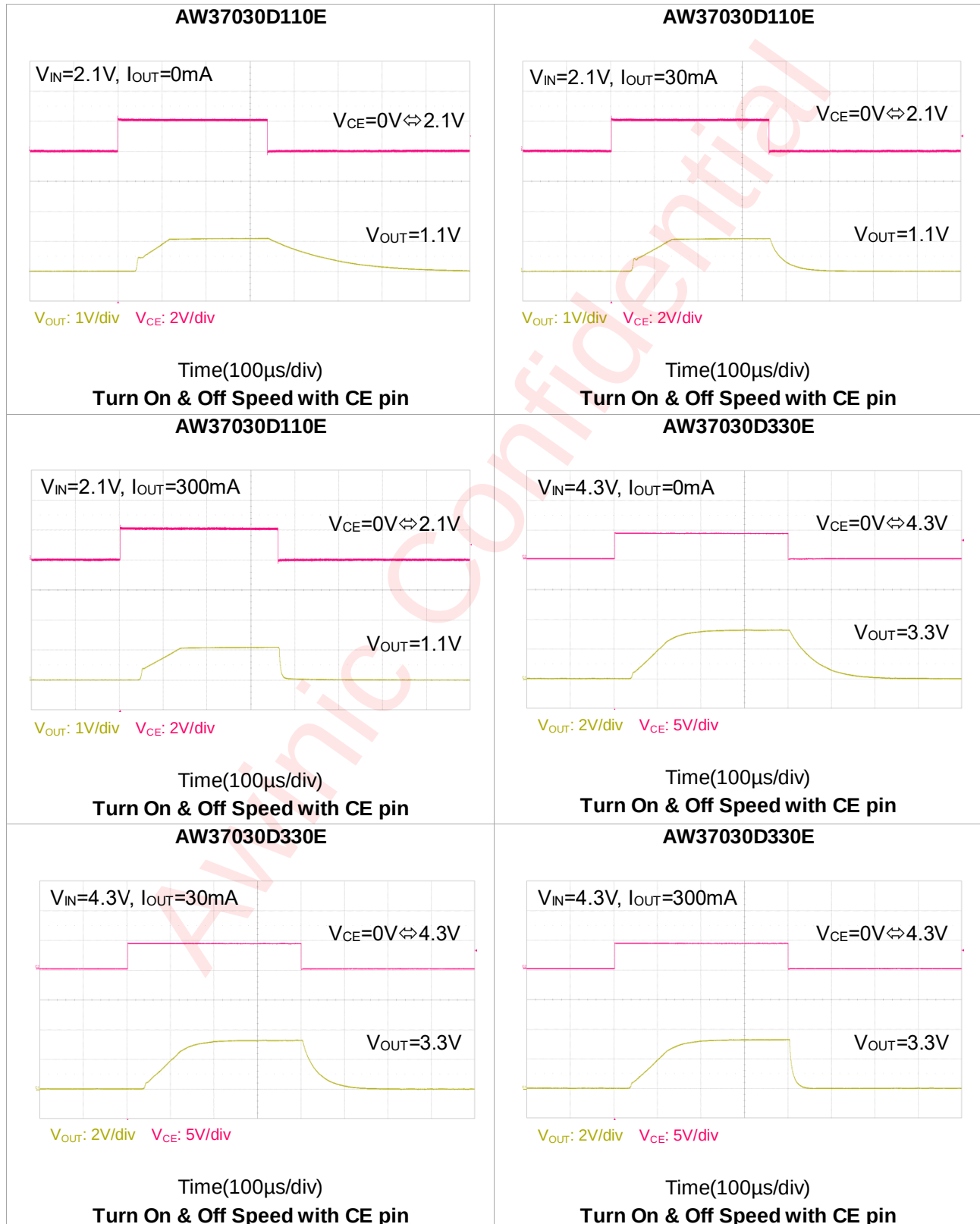
Typical Characteristics (Continued)

$V_{IN}=V_{OUT(SET)}+1V$, $V_{CE}>1V$, $I_{OUT}=1mA$, $C_{IN}=C_{OUT}=1\mu F$, $T_A=25^{\circ}C$, in Typical Application Circuit, unless otherwise noted.



Typical Characteristics (Continued)

$V_{IN}=V_{OUT(SET)}+1V$, $V_{CE}\geq 1V$, $I_{OUT}=1mA$, $C_{IN}=C_{OUT}=1\mu F$, $T_A=25^\circ C$, in Typical Application Circuit, unless otherwise noted.



Detailed Functional Description

AW37030YXXXE is a low dropout voltage regulator. After powered on, with CE pin assertion, feedback voltage signal from the integrated resistor network and a voltage related to the voltage reference are transmit to positive and negative input terminals of an error amplifier (EA) respectively. The output signal of EA is used to control the open-state of power MOSFET. After soft-start, feedback voltage signal compares with the established reference voltage, making output voltage stable and accurate. AW37030YXXXE integrates function of load transient accelerating, making LDO obtain excellent dynamic load transient response performance.

Enable Operation

AW37030YXXXE uses CE pin to realize enable operation. Applying proper value of voltage to CE pin can make IC enable/disable.

If the voltage of CE pin is less than 0.4V, AW37030YXXXE is guaranteed to be disabled. In this state, function modules of IC and power MOSFET are turned off. And the auto discharge function is enabled making output discharge through a on-state NMOSFET to Ground. In disable state, AW37030YXXXE only consumes a typical 10nA current.

If the voltage of CE pin is more than 1V, AW37030YXXXE is guaranteed to be enabled. In this state, the auto discharge function is disabled, and AW37030YXXXE regulates output voltage to the designed value of voltage.

A 140nA pull down current to Ground is built-in at CE pin, making sure that the IC is disabled when CE pin floats. If Enable function is not required, CE pin should be connected directly to IN pin.

Output Current Limit

AW37030YXXXE integrates output current limit function, protecting IC from excessive current.

When the load is excessively heavy, AW37030YXXXE limits the current flowing through the IC to a typical 500mA current. This value is specially designed, so that IC is protected properly and the output capability of 300mA is not influenced either.

Meanwhile, AW37030YXXXE integrates a 120mA fold-back current limit function, lowering the system dissipation when output overload or short to Ground.

Thermal Shutdown

AW37030YXXXE integrates thermal shutdown function, protect IC from excessively high temperature.

When the chip temperature exceeds 160°C, AW37030YXXXE detects it as an over-temperature event, triggering thermal shutdown, which will turn off the main function module, including power MOSFET. This inhibits increase of chip's temperature. IC would keep the protection-state on until the chip's temperature falls below to 130°C. At this moment, the over-temperature protection-state is released, IC resumes to work again. The hysteresis avoids IC's turning off and on frequently around the the Thermal Shutdown threshold.

Auto Discharge

AW37030YXXXE makes output voltage discharge quickly when in CE disable state or thermal shutdown state, benefit from integrating auto discharge function. Auto discharge function is implemented by integrated a NMOSFET of typical 130Ω Rdson route from Output to Ground, and the route is get through in CE disable state or thermal shutdown state. This feature prevents residual charge voltage on the output capacitor, which may impact proper power up of the system connected to the converter. It should be noted that auto discharge function is optional according to different specs.

Application Information

Power Dissipation and Device Operation

The permissible power dissipation is dependent on the ambient temperature T_A and the junction-to-ambient thermal resistance $R_{\theta JA}$.

The absolute maximum allowable power dissipation for the device in a given package can be calculated using Equation below, where $T_{J_MAX} = 150^{\circ}\text{C}$:

$$PD_{MAX_ABS} = (T_{J_MAX} - T_A) / R_{\theta JA}$$

The recommended maximum allowable power dissipation for the device in a given package can be calculated using Equation below, where $T_{J_REC} = 125^{\circ}\text{C}$:

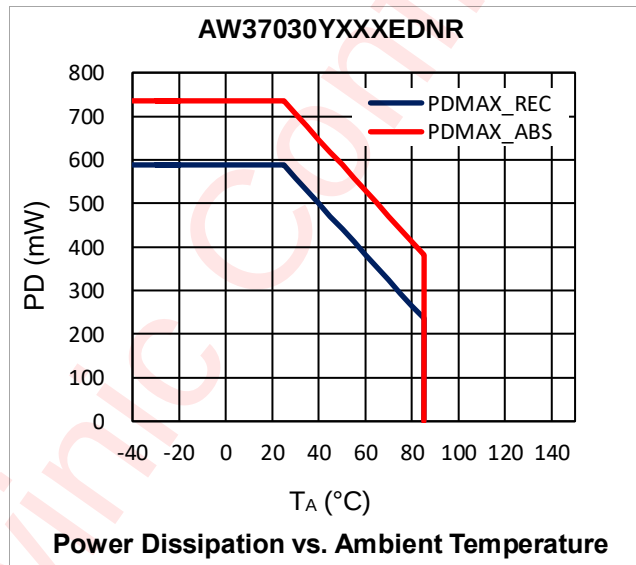
$$PD_{MAX_REC} = (T_{J_REC} - T_A) / R_{\theta JA}$$

The actual power being dissipated in the device can be represented by Equation below:

$$PD_{ACT} = (V_{IN} - V_{OUT}) \times I_{OUT}$$

These equations above establish the relationship between the maximum power dissipation allowed due to thermal consideration, the voltage drop across the device, and the continuous current capability of the device.

The graphs of Power Dissipation vs. Ambient Temperature are showed below :



The above graphs show the maximum power dissipation of the respective package at $T_{J_REC} = 125^{\circ}\text{C}$ and $T_{J_MAX} = 150^{\circ}\text{C}$. Operating the device in the region between PD_{MAX_REC} and PD_{MAX_ABS} might have a negative influence on its lifetime.

Capacitors Selection

IN pin: Input Capacitor C_{IN}

AW37030YXXXE advises to use a $1\mu\text{F}$ or more X5R or X7R ceramic capacitor at IN pin as shown in Typical Application Circuit.

OUT pin: Output Capacitor C_{OUT}

AW37030YXXXE advises to use a $1\mu\text{F}$ or more X5R or X7R ceramic capacitor at OUT pin as shown in Typical Application Circuit.

Recommended Components List

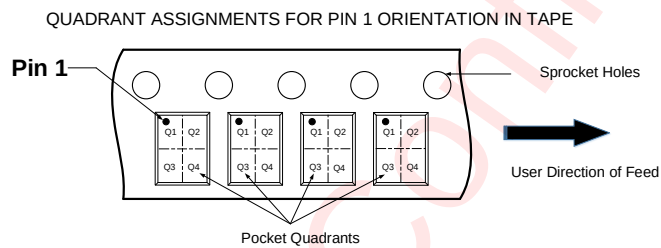
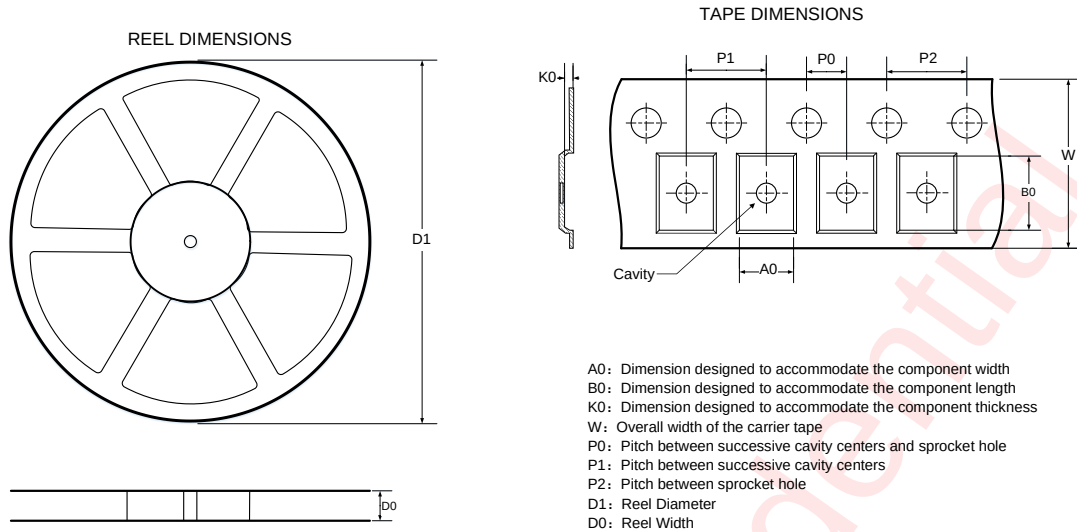
Component	PART No.	DESCRIPTION	MFR	TYP.	UNIT
C _{IN}	GRM155R61A105KE15	10V, X5R, 0402	MURATA	1	μF
C _{OUT}	GRM155R61A105KE15	10V, X5R, 0402	MURATA	1	μF

PCB Layout Consideration

The performance of a power source circuit using this device is highly dependent on a peripheral circuit. To obtain the optimal performance, a peripheral component or the device mounted on PCB should not exceed its rated voltage, rated current or rated power. When designing a peripheral circuit, guidelines below for PCB layout of AW37030YXXXE should be obeyed:

1. All peripheral components should be placed as close to the chip as possible. C_{IN} and C_{OUT} should be close to IN and OUT pins respectively. Avoid connecting device and chip pins with two different layers of copper, use the same layer of copper instead.
2. IN and OUT pin are the large current input and output of the chip, make IN, OUT, and meanwhile GND lines sufficient.
3. The connection lines between the planes of C_{IN} or C_{OUT} and respective chip pin should be as short and wide as possible, to reduce noise and EMI interference, or it may cause noise pickup or unstable operation.
4. The exposed plane of chip and GND pins must be connected to the large-area ground layer of PCB directly, meanwhile place sufficient vias below the exposed plane. Thus we can decrease the thermal resistor on the board to optimize heat-diffusion performance.

Tape And Reel Information



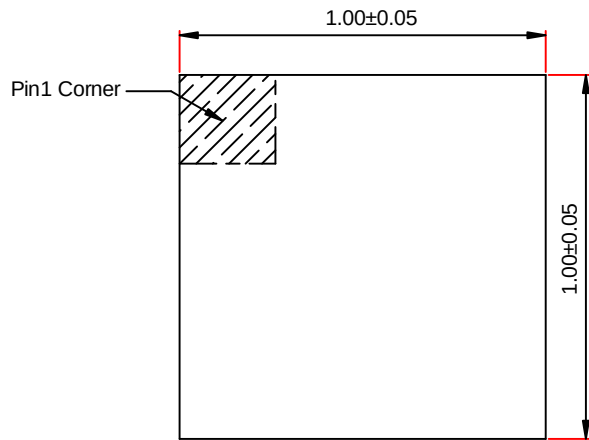
Note: The above picture is for reference only. Please refer to the value in the table below for the actual size

DIMENSIONS AND PIN1 ORIENTATION

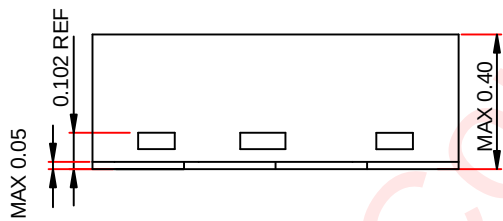
D1 (mm)	D0 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P0 (mm)	P1 (mm)	P2 (mm)	W (mm)	Pin1 Quadrant
178	8.4	1.14	1.17	0.56	2	4	4	8	Q1

All dimensions are nominal

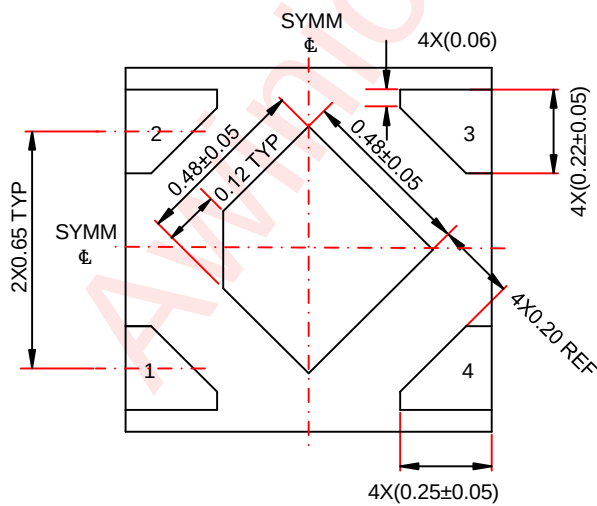
Package Description



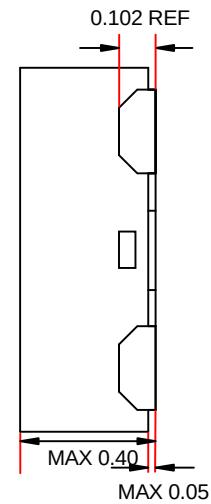
Top View



Side View



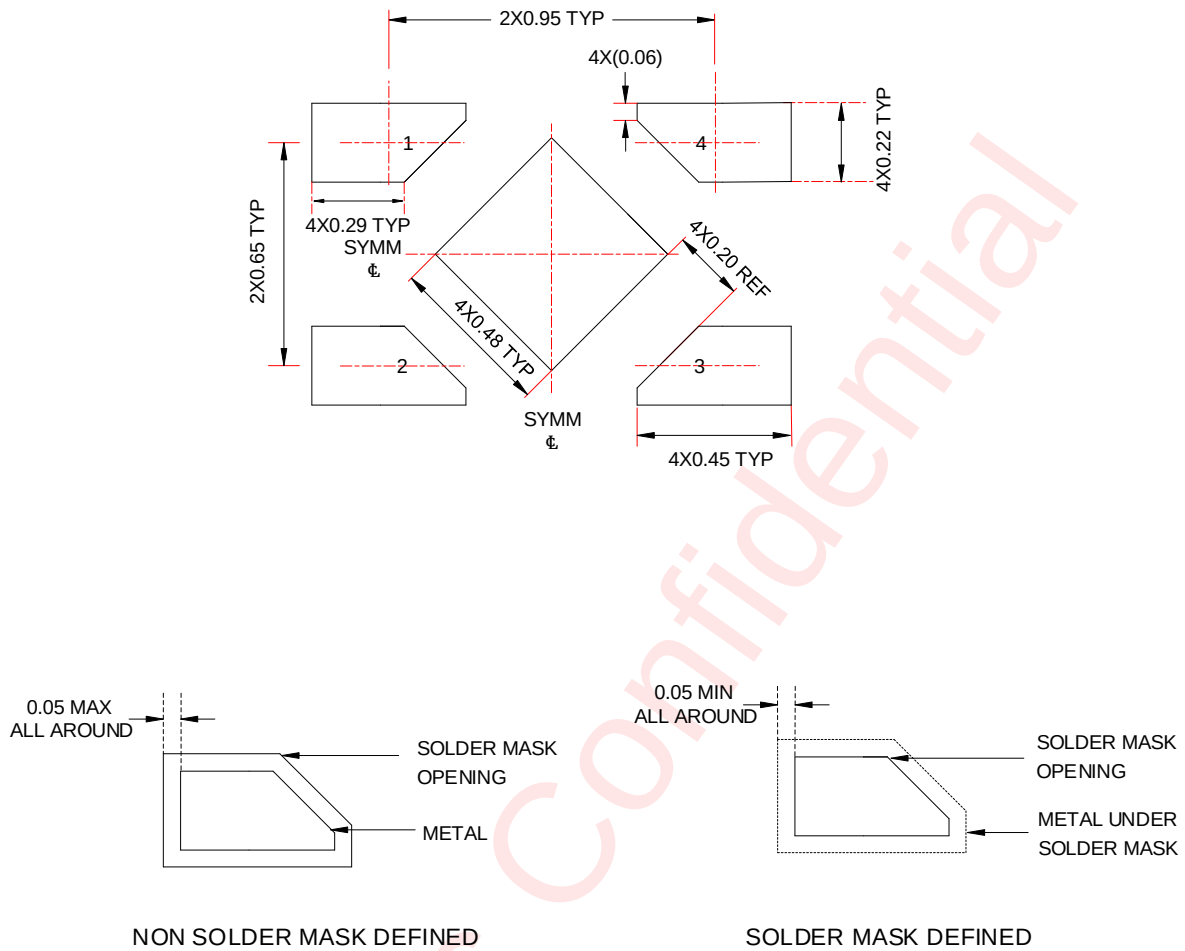
Bottom View



Side View

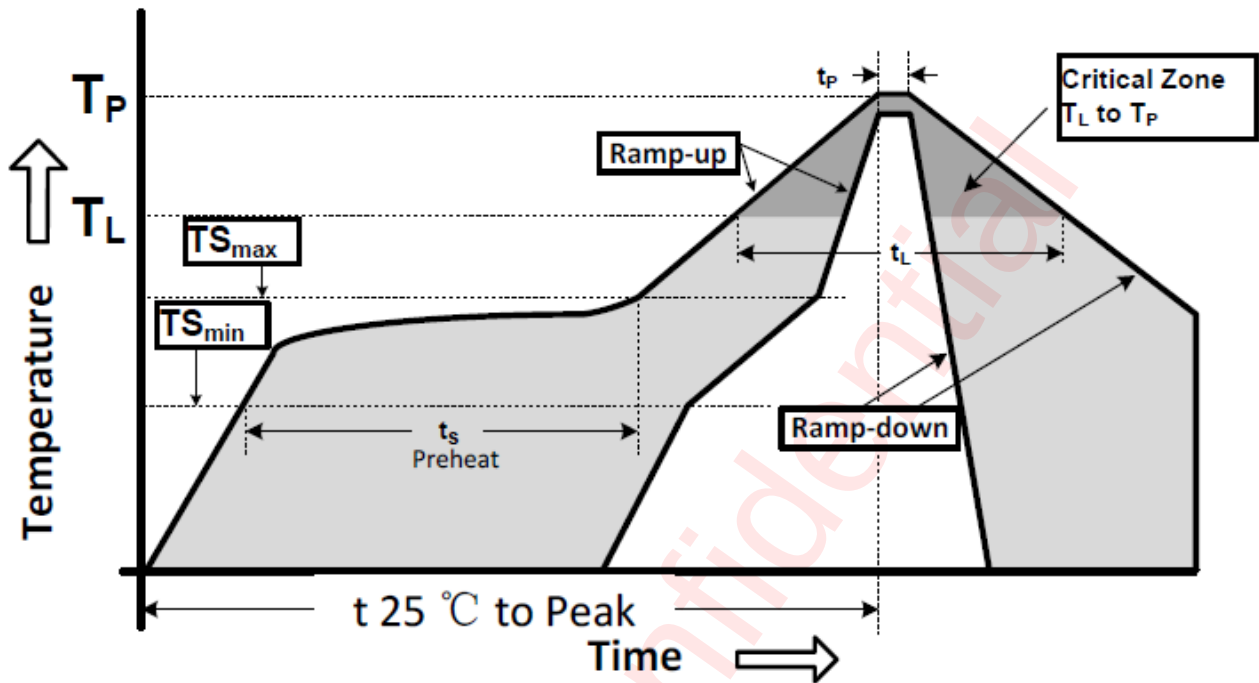
Unit:mm

Land Pattern Data



UNIT : mm

Reflow



Reflow Note	Spec
Ramp-up rate (T_{Smax} to T_P)	3°C/second max.
Preheat temperature (T_{Smin} to T_{Smax})	150°C to 200°C
Preheat time (t_s)	60 - 180 seconds
Time above T_L , 217°C (t_L)	60 - 150 seconds
Peak temperature (T_P)	260°C
Time within 5°C of peak temperature(t_P)	20 - 40 seconds
Ramp-down rate	6°C/second max.
Time 25°C to peak temperature	8 minutes max.

Revision History

Version	Date	Change Record
V1.0	Apr. 2022	Officially released
V1.1	Jun. 2025	Delete the information of AW37030D280EDNR
V1.2	Oct. 2025	Delete the information of AW37030D180EDNR

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